

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

Tallis Y. Chang, et al.

Serial No: Not Assigned

Filed:

Herewith

For:

TAP COUPLERS FOR FIBER

**OPTIC ARRAYS** 

Art Unit: Not Assigned

Examiner: Not Assigned

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## TRANSMITTAL OF INFORMATION **DISCLOSURE STATEMENT**

**BOX PATENT APPLICATION** Commissioner for Patents Washington, D.C. 20231

Dear Sir:

The information disclosure statement submitted herewith is being filed concurrently with the subject application [37 C.F.R. § 1.97(b)] and contains no items of information cited in any communication from a foreign patent office in a counterpart foreign application [37 C.F.R. § 1.97(e)(1)].

Respectfully submitted,

HOGAN & HARTSON L.L.P.

Date: November 6, 2001

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## INFORMATION DISCLOSURE CITATION IN AN APPLICATION

(Use several sheets if necessary)

**Docket Number (Optional)** 82874.0011

**Application Number** 

Not Assigned

**Applicant** 

Tallis Y. Chang, et al.

**Filing Date Group Art Unit** 

**Not Assigned** Herewith



U.S. PATENT DOCUMENTS								
EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE		
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	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	Transl	ation NO	
	OTHER DOCUMENT	S (Including A	uthor, Title, Date, Perti	nent Pages	, Etc.)			
	T. Sasaki, et al., "Multi-Channel Powe Circuit," Optical Society of America, p	er Level Monitor p. WB6-1-WB6	with Upward-Reflector a 3, 2000.	and Sensor-A	Array Integrated	in Planar Lig	ghtwave	

EXAMINER	
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**DATE CONSIDERED** 

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.